## Abstract

A semiconductor device comprising a metal-oxidesemiconductor field-effect transistor well controllably
brings the work function of a gate electrode close to the
intrinsic mid gap energy of silicon, thereby lowering the
concentration of impurities in a channel. By this, the
deterioration of carrier mobility is prevented and a
metal-oxide-semiconductor field-effect transistor is
obtained. A gate electrode has a multi-layer structure of
a p-type polycrystalline or a single-crystalline germanium
film 3 and a low resistance conductive film 4.